



Dkt. No: AMK-10966

GP 2826  
JFC**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Robert F. Darveaux et al.

Application No.: 09/923,834

Art Unit.: 2826

Filing Date: 08/07/2001

Examiner: Fazli Erdem

For: "Embedded Heat Spreader Ball Grid Array"

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Date: August 5, 2004

**AMENDMENT TRANSMITTAL**

1. Transmitted herewith is an amendment for this application.
2. **STATUS:** Applicant is other than a small entity.
3. **EXTENSION OF TERM:** The proceedings herein are for a patent application and the provisions of 37 C.F.R. 1.136 apply. Applicant believes that no extension of term is required. However, this conditional petition is being made to provide for the possibility that applicant has inadvertently overlooked the need for a petition for extension of time.
4. **FEE FOR CLAIMS:** The fee for claims (37 C.F.R. 1.16(b)-(d)) has been calculated as shown below:

(Col.1)	(Col. 2)	(Col. 3)	LARGE ENTITY		
Claims Remaining After Amendment	Highest No. Previously Paid For	Present Extra	Rate	Addit. Fee	
Total 48	Minus 47	= 1	x \$18 =	\$18	
Indep. 8	Minus 4	= 4	x \$86 =	\$344	
First Presentation of Multiple Dependent Claim			+ \$290 =	\$0	
			Total Addit. Fee	\$362	

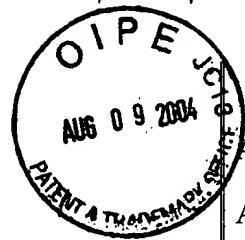
5. **FEE PAYMENT and DEFICIENCY:** Please charge Deposit Acct. 50-0574 the amount of \$362.00 for additional claims and \$180.00 for the Information Disclosure Statement. If any additional extension and/or fee is required, also charge Account No. 50-0574.

  
**SIGNATURE OF PRACTITIONER**  
James E. Parsons  
Reg. No. 34,691

Customer No. 022888  
Tel.: (408) 451-5906

I hereby certify that this correspondence is being deposited with the United States Postal Service as FIRST CLASS MAIL in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 5, 2004.

8/5/2004 Rebecca A. Baumann  
Date Signature: Rebecca A. Baumann



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Robert F. Darveaux et al.  
Assignee: Amkor Technology, Inc.  
Title: Embedded Heat Spreader Ball Grid Array  
Serial No.: 09/923,834 Filing Date: August 7, 2001  
Examiner: Erdem, Fazli Group Art Unit: 2826  
Docket No.: AMK-10966 (M-10966 US)

San Jose, California  
August 5, 2004

COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION MAILED ON 5/20/04

Dear Sir:

In response to the Office Action mailed on May 20, 2004, please amend the application as indicated below, and please consider the remarks provided below.

08/10/2004 BSAYASI1 00000057 500574 09923834

01 FC:1201 344.00 DA  
02 FC:1202 18.00 DA